

High Current Surface Mount PNP Silicon Switching Transistor for Load Management in Portable Applications

MMBT589LT1G, NSVMMBT589LT1G

Features

- NSV Prefix for Automotive and Other Applications Requiring Unique Site and Control Change Requirements; AEC-Q101 Qualified and PPAP Capable
- These Devices are Pb-Free, Halogen Free/BFR Free and are RoHS Compliant

MAXIMUM RATINGS $(T_A = 25^{\circ}C)$

Symbol	Rating	Value	Unit
V _{CEO}	Collector - Emitter Voltage	-30	Vdc
V _{CBO}	Collector - Base Voltage	-50	Vdc
V _{EBO}	Emitter - Base Voltage	-5.0	Vdc
I _C	Collector Current - Continuous	-1.0	Adc
I _{CM}	Collector Current - Peak	-2.0	Α

THERMAL CHARACTERISTICS

Symbol	Characteristic	Max	Unit
P _D	Total Device Dissipation FR-5 Board, (Note 1) T _A = 25°C Derate above 25°C	310 2.5	mW mW/°C
$R_{\theta JA}$	Thermal Resistance Junction-to-Ambient (Note 1)	403	°C/W
P _D	Total Device Dissipation Alumina Substrate, (Note 2) T _A = 25°C Derate above 25°C	710 5.7	mW mW/°C
$R_{\theta JA}$	Thermal Resistance Junction-to-Ambient (Note 2)	176	°C/W
P _{Dsingle}	Total Device Dissipation (Ref. Figure 8) (Single Pulse < 10 sec.)	575	mW
T _J , T _{stg}	Junction and Storage Temperature	-55 to +150	°C

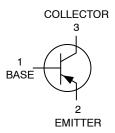
Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

1

- 1. FR-4@ Minimum Pad
- 2. FR-4 @ 1.0 X 1.0 inch Pad

30 VOLTS, 2.0 AMPS PNP TRANSISTORS





MARKING DIAGRAM



G3 = Device Code
M = Date Code*

• = Pb-Free Package

(Note: Microdot may be in either location)
*Date Code orientation and/or overbar may vary depending upon manufacturing location.

ORDERING INFORMATION

Device	Package	Shipping [†]
MMBT589LT1G	SOT-23 (Pb-Free)	3,000 / Tape & Reel
NSVMMBT589LT1G	SOT-23 (Pb-Free)	3,000 / Tape & Reel

†For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specification Brochure, BRD8011/D.

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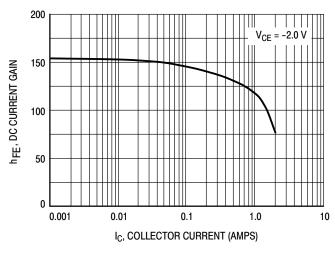
ELECTRICAL CHARACTERISTICS (T_A = 25°C unless otherwise noted)

Symbol	Characteristic	Min	Max	Unit	
OFF CHARACTERISTICS					
V _{(BR)CEO}	Collector – Emitter Breakdown Voltage ($I_C = -10$ mAdc, $I_B = 0$)	 -30	-	Vdc	
V _{(BR)CBO}	Collector – Base Breakdown Voltage $(I_C = -0.1 \text{ mAdc}, I_E = 0)$	-50	-	Vdc	
V _{(BR)EBO}	Emitter – Base Breakdown Voltage ($I_E = -0.1 \text{ mAdc}, I_C = 0$)	-5.0	-	Vdc	
I _{CBO}	Collector Cutoff Current (V _{CB} = -30 Vdc, I _E = 0)	-	-0.1	μAdc	
I _{CES}	Collector-Emitter Cutoff Current (V _{CES} = -30 Vdc)	-	-0.1	μAdc	
I _{EBO}	Emitter Cutoff Current (V _{EB} = -4.0 Vdc)	-	-0.1	μAdc	
ON CHARA	ON CHARACTERISTICS				
h _{FE}	DC Current Gain (Note 3) (Figure 1) $ \begin{array}{l} (I_C = -1.0 \text{ mA, } V_{CE} = -2.0 \text{ V}) \\ (I_C = -500 \text{ mA, } V_{CE} = -2.0 \text{ V}) \\ (I_C = -500 \text{ mA, } V_{CE} = -2.0 \text{ V}) \\ (I_C = -1.0 \text{ A, } V_{CE} = -2.0 \text{ V}) \\ (I_C = 2.0 \text{ A, } V_{CE} = -2.0 \text{ V}) \end{array} $	100 100 80 40	- 300 - -	-	
V _{CE(sat)}	Collector – Emitter Saturation Voltage (Note 3) (Figure 3) $ \begin{array}{l} (I_C=-0.5~A,~I_B=-0.05~A)\\ (I_C=-1.0~A,~I_B=0.1~A)\\ (I_C=-2.0~A,~I_B=-0.2~A) \end{array} $	- - -	-0.25 -0.30 -0.65	V	
V _{BE(sat)}	Base – Emitter Saturation Voltage (Note 3) (Figure 2) $(I_C = -1.0 \text{ A}, I_B = -0.1 \text{ A})$	-	-1.2	V	
V _{BE(on)}	Base – Emitter Turn–on Voltage (Note 3) $(I_C = -1.0 \text{ A}, V_{CE} = -2.0 \text{ V})$	-	-1.1	V	
f _T	Cutoff Frequency ($I_C = -100$ mA, $V_{CE} = -5.0$ V, f = 100 MHz)	100	-	MHz	
Cobo	Output Capacitance (f = 1.0 MHz)	-	15	pF	

Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions.

3. Pulsed Condition: Pulse Width = 300 msec, Duty Cycle ≤ 2%

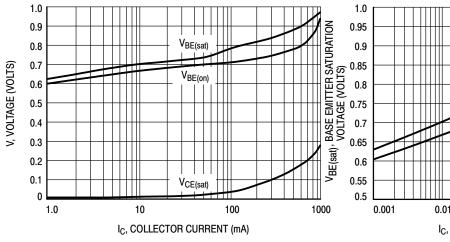
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230 V_{CE} = -1.0 V 210 125°C 190 hFE, DC CURRENT GAIN 170 150 25°C 130 110 90 -55°C 70 50 1.0 10 100 1000 IC, COLLECTOR CURRENT (mA)

Figure 1. DC Current Gain versus Collector Current

Figure 2. DC Current Gain versus Collector Current



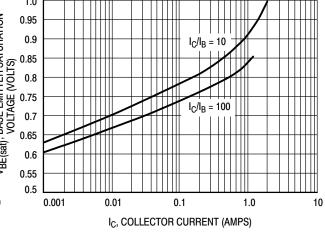
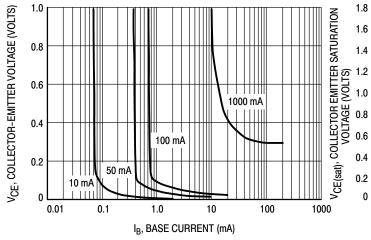


Figure 3. "On" Voltages

Figure 4. Base Emitter Saturation Voltage versus Collector Current



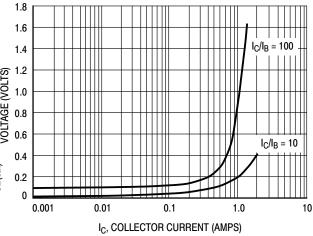


Figure 5. Collector Emitter Saturation Voltage versus Collector Current

Figure 6. Collector Emitter Saturation Voltage versus Collector Current

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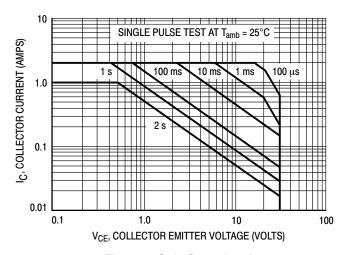


Figure 7. Safe Operating Area

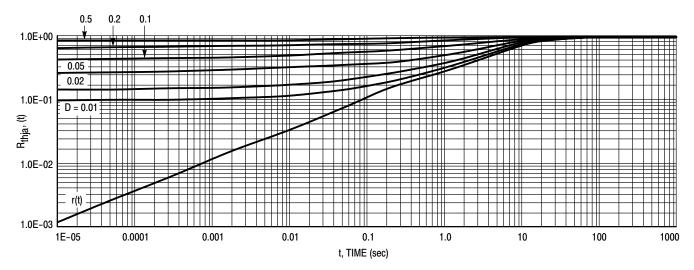


Figure 8. Normalized Thermal Response

MILLIMETERS

MIN

0.89

0.01

0.37

0.08

2.80

1.20

1.78

0.30

0.35

2.10

O°

NOM

1.00

0.06

0.44

0.14

2.90

1.30

1.90

0.43

0.54

2.40





SOT-23 (TO-236) 2.90x1.30x1.00 1.90P **CASE 318 ISSUE AU**

DATE 14 AUG 2024

MAX

1.11

0.10

0.50

0.20

3.04

1.40

2.04

0.55

0.69

2.64

10°





DETAIL "A" Scale 3:1







NOTES:

DIM

Α

Α1

b

С

D

Ε

е L

L1

HE

Τ

- DIMENSIONING AND TOLERANCING 1. PER ASME Y14.5M, 2018. CONTROLLING DIMENSIONS:
- MILLIMETERS.
- MAXIMUM LEAD THICKNESS INCLUDES LEAD FINISH. MINIMUM LEAD THICKNESS IS THE MINIMUM THICKNESS OF THE
- BASE MATERIAL.
 DIMENSIONS D AND E DO NOT INCLUDE MOLD FLASH, PROTRUSIONS, OR GATE BURRS.

GENERIC MARKING DIAGRAM*



XXX = Specific Device Code

= Date Code

= Pb-Free Package

RECOMMENDED MOUNTING FOOTPRINT

* For additional information on our Pb-Free strategy and soldering details, please download the onsemi Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

STYLES ON PAGE 2

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^{*}This information is generic. Please refer to device data sheet for actual part marking. Pb-Free indicator, "G" or microdot "=", may or may not be present. Some products may not follow the Generic Marking.

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DATE 14 AUG 2024

STYLE 1 THRU 5: CANCELLED	STYLE 6: PIN 1. BASE 2. EMITTER 3. COLLECTOR			
STYLE 9: PIN 1. ANODE 2. ANODE 3. CATHODE	STYLE 10: PIN 1. DRAIN 2. SOURCE 3. GATE	2. CATHODE 2.	2: STYLE 13: CATHODE PIN 1. SOURCE CATHODE 2. DRAIN ANODE 3. GATE	STYLE 14: PIN 1. CATHODE 2. GATE 3. ANODE
STYLE 15: PIN 1. GATE 2. CATHODE 3. ANODE	STYLE 16: PIN 1. ANODE 2. CATHODE 3. CATHODE	2. ANODE 2.	3: STYLE 19: NO CONNECTION PIN 1. CATHODE CATHODE 2. ANODE ANODE 3. CATHODE-ANODE	STYLE 20: PIN 1. CATHODE 2. ANODE 3. GATE
STYLE 21: PIN 1. GATE 2. SOURCE 3. DRAIN	STYLE 22: PIN 1. RETURN 2. OUTPUT 3. INPUT			STYLE 26: PIN 1. CATHODE 2. ANODE 3. NO CONNECTION
STYLE 27: PIN 1. CATHODE 2. CATHODE 3. CATHODE	STYLE 28: PIN 1. ANODE 2. ANODE 3. ANODE			

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